

Z88 Motherboard Modifications

Updated 21 January 2005

Internal RAM

Z88 PCB				32K				128K				512K			
POE	1	+++	32 VCC					NC	1	+++	32 VCC	A18	1	+++	
A16	2		31 A15					A16	2		31 A15	A16	2		
A14	3		30 VCC	A14	1	+++	28 VCC	A14	3		30 CS2	A14	3		
A12	4		29 /WE	A12	2		27 /WE	A12	4		29 /WE	A12	4		
A7	5		28 A13	A7	3		26 A13	A7	5		28 A13	A7	5		
A6	6		27 A8	A6	4		25 A8	A6	6		27 A8	A6	6		
A5	7		26 A9	A5	5		24 A9	A5	7		26 A9	A5	7		
A4	8		25 A11	A4	6		23 A11	A4	8		25 A11	A4	8		
A3	9		24 /OE	A3	7		22 /OE	A3	9		24 /OE	A3	9		
A2	10		23 A10	A2	8		21 A10	A2	10		23 A10	A2	10		
A1	11		22 /CE	A1	9		20 /CS1	A1	11		22 /CS1	A1	11		
A0	12		21 D7	A0	10		19 D7	A0	12		21 D7	A0	12		
D0	13		20 D6	D0	11		18 D6	D0	13		20 D6	D0	13		
D1	14		19 D5	D1	12		17 D5	D1	14		19 D5	D1	14		
D2	15		18 D4	D2	13		16 D4	D2	15		18 D4	D2	15		
VSS	16		17 D3	VSS	14		15 D3	VSS	16		17 D3	VSS	16		

Original pseudostatic RAM: NEC D42832C-12L
-15L

Tested static RAM:

Hyundai HY62256ALP-10	Mitsubishi M5M51008AP-70	Hitachi HM628512
Hyundai HY62256ALP-70	BSI BS62LV1024PC-70 New and	
Hitachi HM62256LP-10	tested by Per Svensson 21 January	
NEC D43256C-12L		
Samsung KM62256BLP-10		
Sony CXK58257AP-10L		
Toshiba TC55257PL-12		

Untested static RAM:

NEC μPD431000A	Samsung KM68400C
Samsung KM681000	BSI BS62LV4001PC
Toshiba TC551001	

Internal ROM

Z88 PCB				128K mask ROM compatible EPROM				128K mask ROM			
VCC	1	+++	32 VCC	VPP	1	+++	32 VCC				
ROE	2		31 VCC	/OE	2		31 /PGM				
A15	3		30 VCC	A15	3		30 NC	A15	1	+++	28 VCC
A12	4		29 A14	A12	4		29 A14	A12	2		27 A14
A7	5		28 A13	A7	5		28 A13	A7	3		26 A13
A6	6		27 A8	A6	6		27 A8	A6	4		25 A8
A5	7		26 A9	A5	7		26 A9	A5	5		24 A9
A4	8		25 A11	A4	8		25 A11	A4	6		23 A11
A3	9		24 A16	A3	9		24 A16	A3	7		22 A16
A2	10		23 A10	A2	10		23 A10	A2	8		21 A10
A1	11		22 CE	A1	11		22 /CE	A1	9		20 /CE
A0	12		21 D7	A0	12		21 D7	A0	10		19 D7
D0	13		20 D6	D0	13		20 D6	D0	11		18 D6
D1	14		19 D5	D1	14		19 D5	D1	12		17 D5
D2	15		18 D4	D2	15		18 D4	D2	13		16 D4
VSS	16		17 D3	VSS	16		17 D3	VSS	14		15 D3

Original NEC μPD27C1000D-20 NEC D23C1000

Tested Intel D27C100 (Of 10 tested 1 or 2 seems to work unreliably in the Z88)

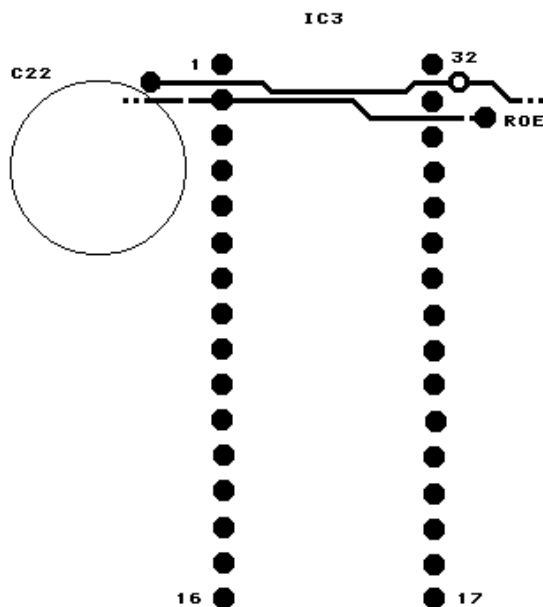
Untested

Hitachi HN27C301G-20
 Toshiba TC571001D-20
 AMD 27C100

JEDEC compatible EPROMs

128K				256K				512K			
+-----+				+-----+				+-----+			
VPP	1	+---+	32 VCC	VPP	1	+---+	32 VCC	VPP	1	+---+	32 VCC
A16	2		31 /PGM	A16	2		31 /PGM	A16	2		31 A18
A15	3		30 NC	A15	3		30 A17	A15	3		30 A17
A12	4		29 A14	A12	4		29 A14	A12	4		29 A14
A7	5		28 A13	A7	5		28 A13	A7	5		28 A13
A6	6		27 A8	A6	6		27 A8	A6	6		27 A8
A5	7		26 A9	A5	7		26 A9	A5	7		26 A9
A4	8		25 A11	A4	8		25 A11	A4	8		25 A11
A3	9		24 /OE	A3	9		24 /OE	A3	9		24 /OE
A2	10		23 A10	A2	10		23 A10	A2	10		23 A10
A1	11		22 /CE	A1	11		22 /CE	A1	11		22 /CE
A0	12		21 D7	A0	12		21 D7	A0	12		21 D7
D0	13		20 D6	D0	13		20 D6	D0	13		20 D6
D1	14		19 D5	D1	14		19 D5	D1	14		19 D5
D2	15		18 D4	D2	15		18 D4	D2	15		18 D4
VSS	16		17 D3	VSS	16		17 D3	VSS	16		17 D3
+-----+				+-----+				+-----+			
Hitachi 27C101 ST M27C1001				ST M27C2001				Hitachi 27C4001 ST M27C4001			

Motherboard Modifications



DG

Component side of board.

To use JEDEC EPROM for internal ROM:

Disconnect IC3 pin 2 from the ROE track by cutting it in two places on the component side of the board. The adjacent A16 track is shown for clarity because the view is usually obscured by a socket. Disconnect IC3 pin 24 from the A16 track by cutting it on the solder side of the board. Connect IC3 pin 24 to the ROE pad close to IC3 pin 17.

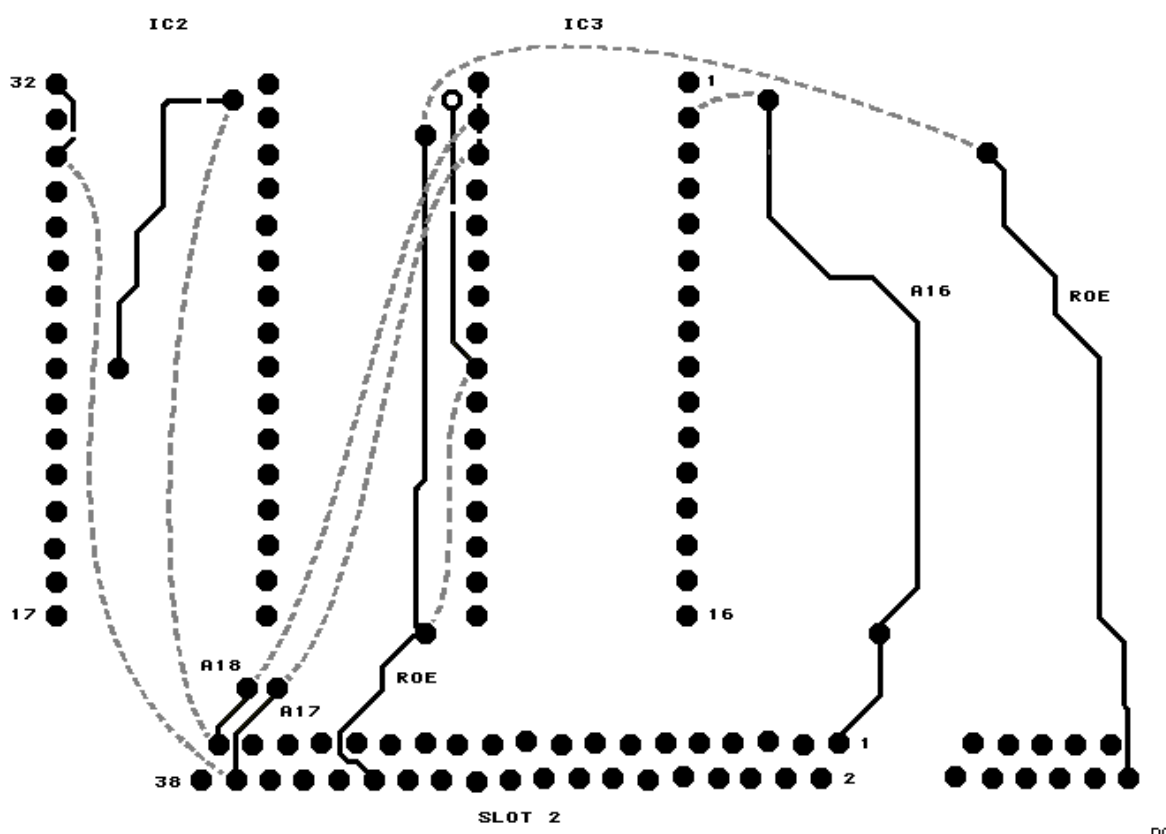
Connect the ROE pad close to IC3 pin 31 to the ROE track going to SLOT 1.
Connect IC3 pin 2 to the A16 track going to SLOT 2.

To use 256K JEDEC EPROM for internal ROM:

Also disconnect IC3 pin 30 from VCC by cutting the track from pin 31.
Connect IC3 pin 30 to the A17 track going to slot 2 pin 36.
128K JEDEC EPROM should still work but is not tested.

To use 512K JEDEC EPROM for internal ROM:

Also disconnect IC3 pin 31 from VCC by cutting the track from pin 32.
Connect IC3 pin 31 to the A18 track going to slot 2 pin 37.
Not sure if 128K or 256K JEDEC EPROM can be used after this modification because of pin 31 /PGM.
For layout of code on larger than 128K internal ROMs see: [Z88 Internal ROM Modifications](#)



Solder side of board.

To use 128K static RAM for internal RAM:

No track changes needed.

To use 512K static RAM for internal RAM:

Disconnect IC2 pin 30 from the VCC by cutting the track from pin 32.
Connect IC2 pin 30 to A17 at slot 2 pin 36.
Disconnect IC2 pin 31 from the /PGM track by cutting it close to the pad near pin 1 and 2.
Connect the IC2 pin 31 to A18 at slot 2 pin 37.
Not sure if 128K static RAM can be used after this modification because of pin 30 CS2.

Desoldering multi-pin chips is difficult. To make it easier, cut all pins close to the chip and unsolder them one at a time.

Installing the chips in a socket is recommended. A low profile socket is a must. Even so, the keyboard reaction plate may have to be cleared of reinforcement webs like it is above the ROM chip.

There are ultra low sockets that makes the RAM chip fit without clearing the reinforcements. **Tested by Per Svensson 21 January**

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